

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	120	V
Average Rectified Output Current	I _O	12	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	250	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	27	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

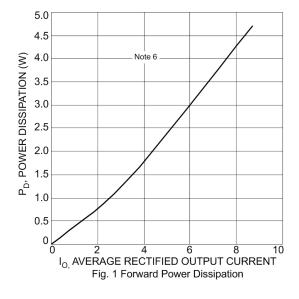
Electrical Characteristics (@ $T_A = +25$ °C, unless otherwise specified.)

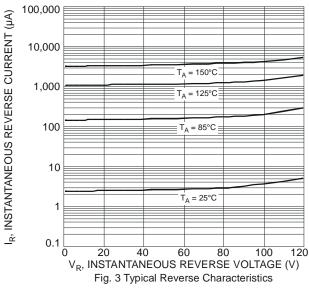
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	\/	=	=	0.80	\/	I _F = 12A, T _J = +25°C
Forward Voltage Drop	V _F	-	0.63	0.68	V	I _F = 12A, T _J = +125°C
Leakage Current (Note 7)	I _R	-	-	0.25	m M	$V_R = 120V, T_J = +25^{\circ}C$
		-	2	35		$V_R = 120V, T_J = +125$ °C

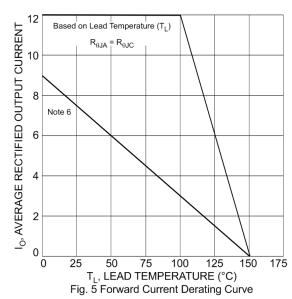
Notes:

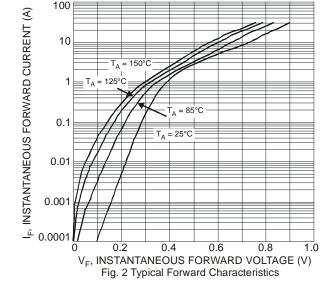
- 6. Device mounted on Polymide PCB with 16x recommended pad layout.
- 7. Short duration pulse test used to minimize self-heating effect.

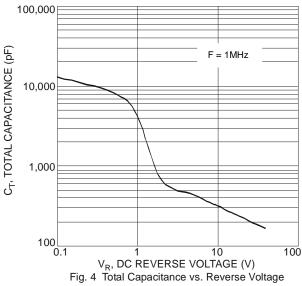


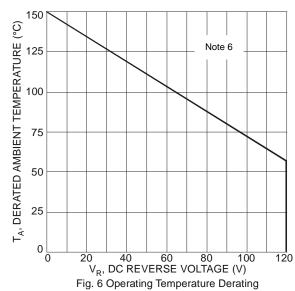








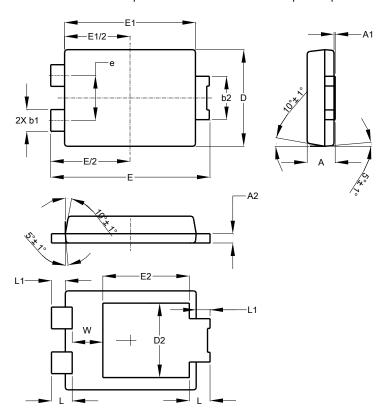






Package Outline Dimensions

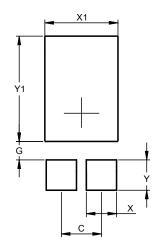
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



POWERDI [®] 5					
Dim	Min	Max	Тур		
Α	1.05	1.15	1.10		
A 1	0.00	0.05			
A2	0.33	0.43	0.381		
b1	0.80	0.99	0.89		
b2	1.70	1.88	1.78		
D	3.90	4.05	3.966		
D2			3.054		
Е	6.40	6.60	6.504		
е			1.84		
E1	5.30	5.45	5.37		
E2			3.549		
L	0.75	0.95	0.85		
L1	0.50	0.65	0.57		
W	1.10	1.41	1.255		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	1.390
X1	3.360
Y	1.400
Y1	4.860



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